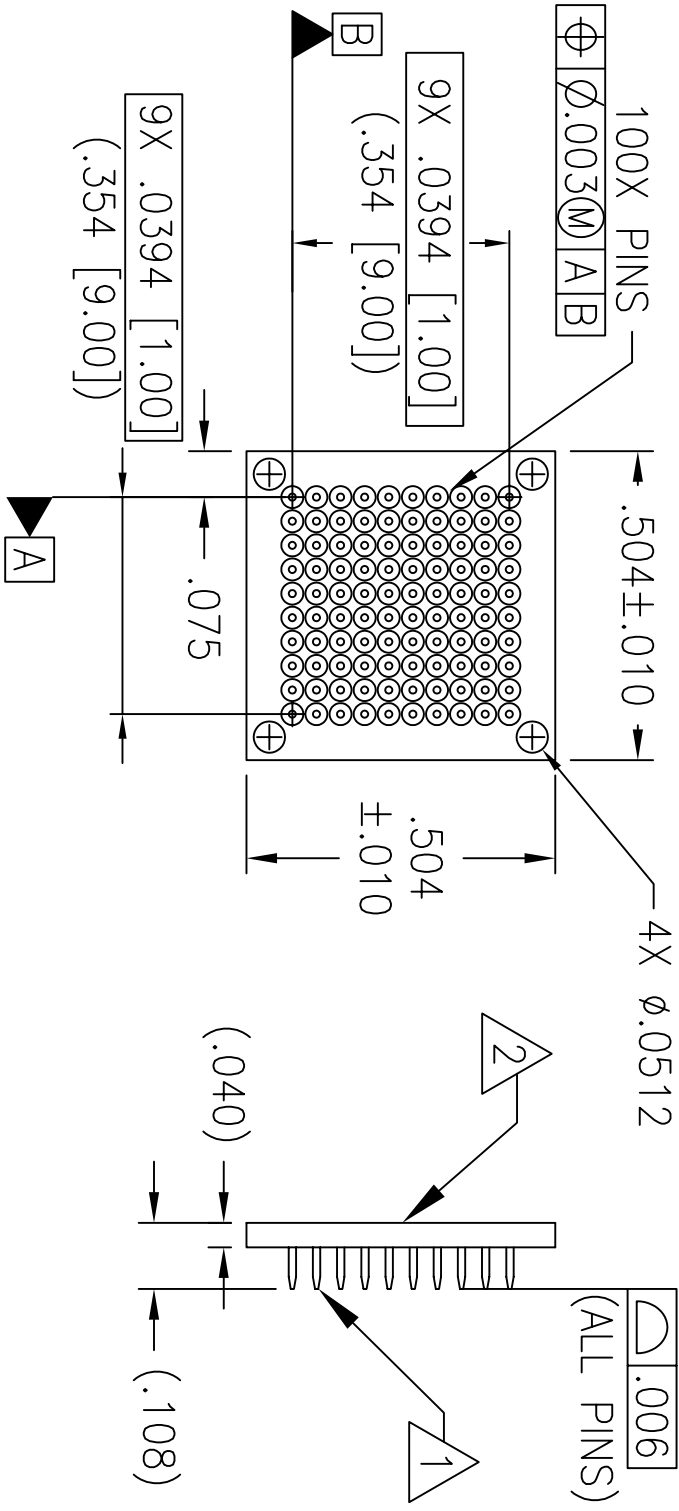


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REV	DESCRIPTION	ECN	DATE	RELEASE
1	SALES RELEASE			

TOP VIEW

RS VIEW



NOTES:

- PINS ϕ .01117
MATERIAL: PHOSPHOR BRONZE.
PLATING: HARD GOLD OVER NICKEL.
- INSULATOR MATERIAL: FR4.

UNLESS OTHERWISE SPECIFIED: DIMENSIONS ARE IN INCHES TOLERANCES: ANGLES: \pm FINISHES: DECIMALS: .XXX \pm .010 .XXXX \pm .005 .XXXXX \pm .0005		CONTRACT NO.	DRAWN BY	DATE	TITLE	SCALE	DRAWING NO.	REV
	DESIGNER		DATE	HILo-NGA PIN BASE 10 X 10, 100 PINS 1mm PITCH	N/A	HLP-100100-B-10	1	
	CHECKER		DATE		FINISHED ASST: HLP-100100-B-10			
	PROCESS ENG.		DATE	SAWD AS: HLP-100100-B-10/DWG				



INTERCONNECT SYSTEMS INC.
708 VIA ALONDRA, CAMARILLO, CA 93012

ASIZE

4

3

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1

A

B

C

D

A

B

C

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